#### MOTOPOLAOL供应商 Freescale SemiconductoryBINC. , 24小时加急出货 SEMICONDUCTOR TECHNICAL DATA

by MRF9130L/D

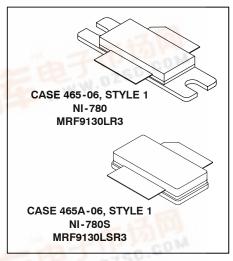
# The RF Sub-Micron MOSFET Line **RF Power Field Effect Transistors** N-Channel Enhancement-Mode Lateral MOSFETs

Designed for GSM and GSM EDGE base station applications with frequencies from 921 to 960 MHz, the high gain and broadband performance of these devices make them ideal for large-signal, common-source amplifier applications in 28 volt base station equipment.

- Typical Performance for GSM Frequencies, 921 to 960 MHz, 28 Volts Output Power @ P1dB — 135 Watts Power Gain — 16.5 dB @ 130 Watts Output Power Efficiency - 48% @ 130 Watts Output Power
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity •
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 28 Vdc, All Frequency Band, 130 Watts CW Output Power
- **Excellent Thermal Stability**
- Characterized with Series Equivalent Large-Signal Impedance Parameters •
- Low Gold Plating Thickness on Leads, 40µ" Nominal. •
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel. • WWW.DZSG



**GSM/GSM EDGE** 921-960 MHz, 130 W, 28 V LATERAL N-CHANNEL **RF POWER MOSFETs** 



#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	Vdc
Gate-Source Voltage	V <sub>GS</sub>	- 0.5, +15	Vdc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	298 1.7	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	- 65 to +200	°C
Operating Junction Temperature	TJ	200	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case		0.6	°C/W

#### **ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M2 (Minimum)
Charge Device Model	C7 (Minimum)

NOTE - CAUTION - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

MOTOROLA

digital dna



Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 65 Vds, V <sub>GS</sub> = 0 Vdc)	I <sub>DSS</sub>	_	_	10	μAdc
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28 \text{ Vds}, V_{GS} = 0 \text{ Vdc}$ )	I <sub>DSS</sub>	_	_	1	μAdc
Gate-Source Leakage Current ( $V_{GS} = 5 Vdc, V_{DS} = 0 Vdc$ )	I <sub>GSS</sub>	_	_	1	μAdc
ON CHARACTERISTICS	•	•			
Gate Threshold Voltage $(V_{DS} = 10 \text{ Vdc}, I_D = 450 \mu \text{Adc})$	V <sub>GS(th)</sub>	2	3	4	Vdc
Gate Quiescent Voltage (V <sub>DS</sub> = 28 Vdc, I <sub>D</sub> = 1000 mAdc)	V <sub>GS(Q)</sub>		3.6	_	Vdc
Drain-Source On-Voltage (V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 3 Adc)	V <sub>DS(on)</sub>		0.2	0.4	Vdc
Forward Transconductance $(V_{DS} = 10 \text{ Vdc}, I_D = 9 \text{ Adc})$	9fs		12	_	S
DYNAMIC CHARACTERISTICS (1)			•	•	*
Output Capacitance (V <sub>DS</sub> = 28 Vdc $\pm$ 30 mV(rms)ac @ 1 MHz, V <sub>GS</sub> = 0 Vdc)	C <sub>oss</sub>		110	_	pF
Reverse Transfer Capacitance (V <sub>DS</sub> = 28 Vdc $\pm$ 30 mV(rms)ac @ 1 MHz, V <sub>GS</sub> = 0 Vdc)	C <sub>rss</sub>	_	4.4	_	pF
UNCTIONAL TESTS (In Motorola Test Fixture)				-	•
Power Output, 1 dB Compression Point (V <sub>DD</sub> = 28 Vdc, I <sub>DQ</sub> = 1000 mA, f = 921 and 960 MHz)	P1dB	120	135	_	W
Common-Source Amplifier Power Gain $(V_{DD} = 28 \text{ Vdc}, P_{out} = 130 \text{ W}, I_{DQ} = 1000 \text{ mA}, f = 921 \text{ and } 960 \text{ MHz})$	G <sub>ps</sub>	15.5	16.5	_	dB
Drain Efficiency (V_DD = 28 Vdc, P_{out} = 130 W, I_{DQ} = 1000 mA, f = 921 and 960 MHz)	η	43	48	_	%
Input Return Loss ( $V_{DD}$ = 28 Vdc, $P_{out}$ = 130 W, $I_{DQ}$ = 1000 mA, f = 921 and 960 MHz)	IRL	_	-12	-9	dB
Output Mismatch Stress (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 130 W CW, I <sub>DQ</sub> = 1000 mA, f = 921 MHz, VSWR = 5:1, All Phase Angles at Frequency of Tests)	Ψ	No	Degradation Before and	In Output Po d After Test	ower

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

(1) Part is internally input matched.

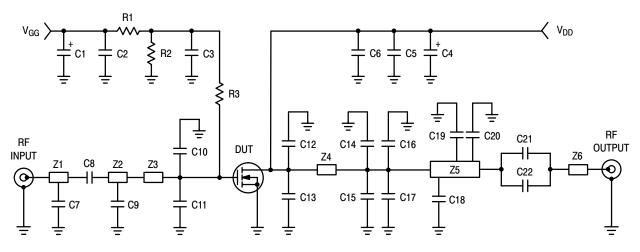
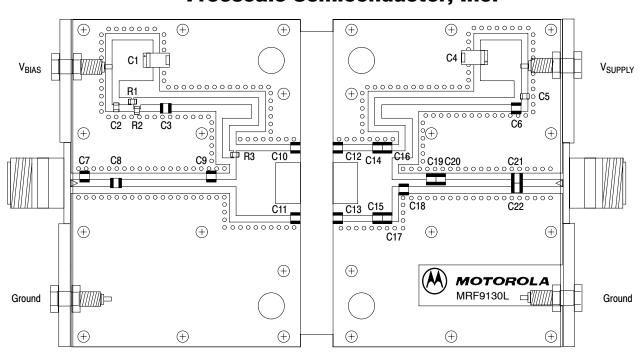


Figure 1. 921-960 MHz Test Circuit Schematic

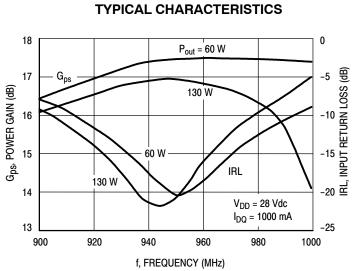
Designators	Description	
C1, C4	10 μF, 35 V Tantalum Capacitors, Vishay-Sprague #293D106X9035D	
C2, C5	100 nF Chip Capacitors (1206), AVX #1206C104KATDA	
C3, C8, C21, C22	22 pF, 100B Chip Capacitors, ATC #100B220C	
C6	33 pF, 100B Chip Capacitor, ATC #100B330JW	
C7	1.0 pF, 100B Chip Capacitor, ATC #100B1R0BW	
C9	4.7 pF, 100B Chip Capacitor, ATC #100B4R7BW	
C10	8.2 pF, 100B Chip Capacitor, ATC #100B8R2CW	
C11	10 pF, 100B Chip Capacitor, ATC #100B100GW	
C12, C13	12 pF, 100B Chip Capacitors, ATC #100B120GW	
C14, C15	2.7 pF, 100B Chip Capacitors, ATC #100B2R7BW	
C16, C17, C18	3.9 pF, 100B Chip Capacitors, ATC #100B3R9BW	
C19	3.3 pF, 100B Chip Capacitor, ATC #100B3R3BW	
C20	1.8 pF, 100B Chip Capacitor, ATC #100B1R8BW	
R1	18 kΩ, 1/8 W Chip Resistor (1206)	
R2	10 kΩ, 1/8 W Chip Resistor (1206)	
R3	1.0 kΩ, 1/8 W Chip Resistor (1206)	
Z1	0.117" x 0.600" Microstrip	
Z2	0.117" x 1.851" Microstrip	
Z3	1.074" x 1.068" Microstrip	
Z4	1.074″ x 0.980″ Microstrip	
Z5	0.117" x 1.933" Microstrip	
Z6	0.117" x 0.605" Microstrip	
РСВ	Taconic TLX8, 0.030", $\varepsilon_r = 2.55$	

Table 1. 921-960 MHz Test Circuit Co	mponent Designations and Values
--------------------------------------	---------------------------------

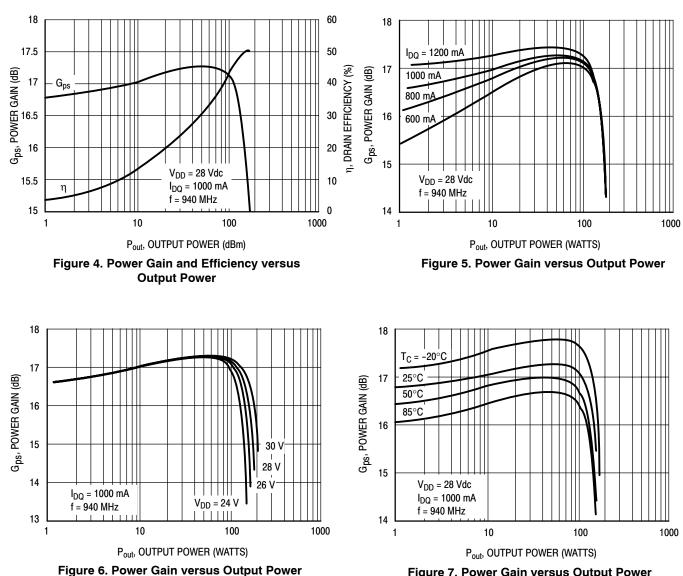


**Freescale Semiconductor, Inc.** 

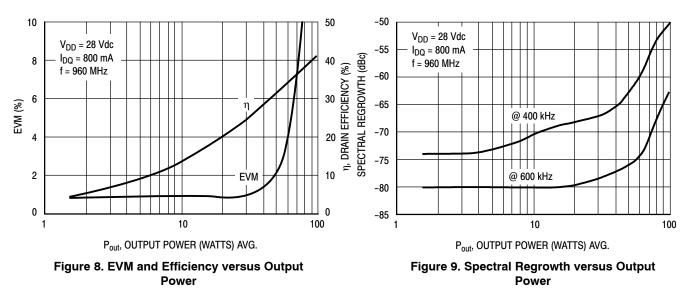
Figure 2. 921-960 MHz Test Circuit Component Layout





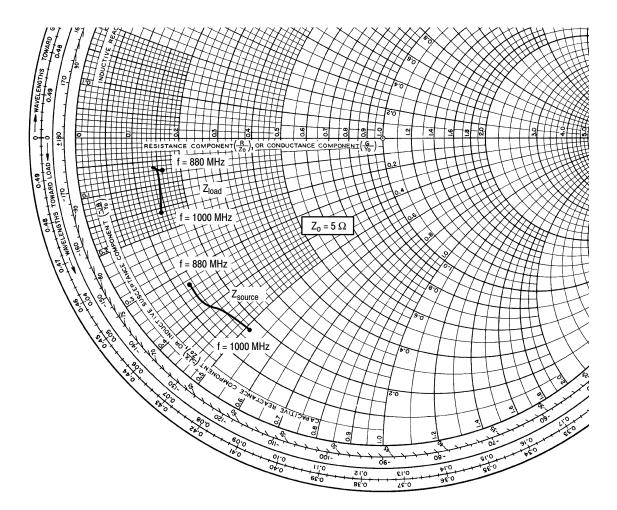


**Freescale Semiconductor, Inc.** 



**TYPICAL CHARACTERISTICS** 

NOTE: Curves on Figure 8 and 9 gathered on a GSM EDGE optimized text fixture.



f MHz	$Z_{source}$	$Z_{load}$
880	0.63 - j1.66	0.82 - j0.36
920	0.67 - j1.88	0.72 - j0.30
960	0.82 - j2.18	0.74 - j0.37
1000	0.86 - j2.56	0.69 - j0.79

 $V_{DD}$  = 28 Vdc,  $I_{DQ}$  = 1000 mA,  $P_{out}$  = 130 W CW

Z<sub>source</sub> = Test circuit impedance as measured from gate to ground.

Z<sub>load</sub> = Test circuit impedance as measured from drain to ground.

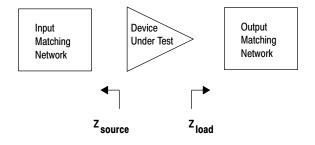
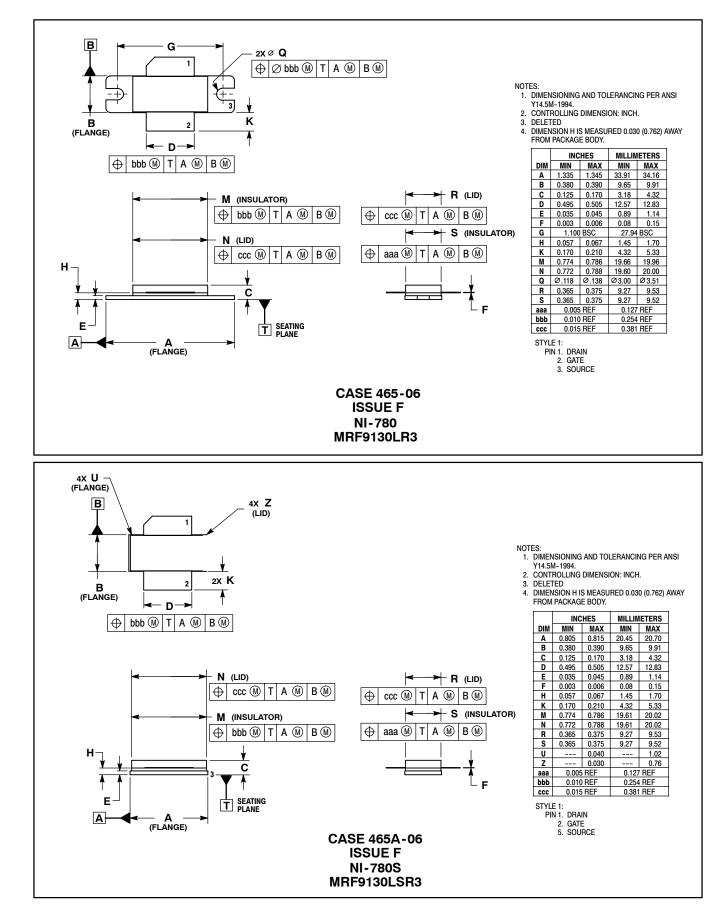


Figure 10. Series Equivalent Input and Output Impedance

# NOTES

# NOTES

PACKAGE DIMENSIONS



Information in this document is provided solely to enable system and software implementers to use Motorola products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part.

MOTOROLA and the Stylized M Logo are registered in the US Patent and Trademark Office. All other product or service names are the property of their respective owners. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

© Motorola Inc. 2004

#### HOW TO REACH US:

USA/EUROPE/LOCATIONS NOT LISTED: Motorola Literature Distribution P.O. Box 5405, Denver, Colorado 80217 1-800-521-6274 or 480-768-2130 JAPAN: Motorola Japan Ltd.; SPS, Technical Information Center, 3-20-1, Minami-Azabu, Minato-ku, Tokyo 106-8573, Japan 81-3-3440-3569

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre, 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong 852-26668334

HOME PAGE: http://motorola.com/semiconductors

